

AS1402 1 Part Non-Corrosive Neutral Cure Adhesive Sealant (Electronic Grade)

Description

This is a heat cured, non-corrosive, neutral cure, 1-part, silicone adhesive sealant. It is one in a range of Addition cure products which are solvent free. It exhibits primerless adhesion to many substrates when cured at temperatures above 100°C. It cures to form a very tough resilient silicone elastomer. This product will not corrode copper or its alloys and is suitable for use with electronic components.

Key Features

- Fast heat cure
- Good adhesion to most substrates
- Non slumping paste
- Translucent

Application

large metal surface areas

Use and Cure Information

This product is a ready to use 1-Part system. It is recommended that liquid versions be thoroughly mixed prior to use, particularly thermally conductive products which are supplied in tubs or pails. Ensure that all surfaces of the substrate are clean and degreased. The work area should be free of contaminants such as organic compounds of sulphur, phosphorus, nitrogen and tin, which act as catalyst poisons.

The rate of cure will depend on how long it takes for the sealant to reach the required curing temperature. Small beads of 1 to 2mm diameter, used as formed-in-place gaskets, can be cured quickly with hot air guns e.g. paint stripper types. With larger sections of sealant or when using as an encapsulant, cure times will increase and the use of an oven will be needed. Increasing the temperature will reduce cure times and maximum cure temperature should not exceed 200°C. All times are based on the actual time in an air-circulating oven at the stated temperature. Note: Improved adhesion is achieved by post cure at 120 to 150°C for 1 to 2 hours.

“For pneumatic dispensing of 310 ml cartridges, the recommended pressure is 2.25 to 3.45 bar (40 to 50 psi). Dispensing pressure above the recommended limits may lead to gas bypassing the piston, causing spluttering at the nozzle and poor bead quality”

Health & Safety

Health and Safety

Safety Data Sheets available on request.

Packaging

CHT Adhesives are available in a variety packaging including cartridges and bulk containers. Please contact our sales department for more information.

Revision Date 12 Feb 2024
Revision No 2
Download Date 22 May 2025

Property

Uncured Product

Appearance

Cure Profile

Cure Type

Extrusion Rate g/min

Rheology

Self Bonding

Cured Product

After 1 hour at 150°C

100% Modulus (N/mm²)

Color

Density

Elongation at Break

Hardness Shore A

Linear Coefficient of Thermal Expansion (ppm/°C)

Linear Shrinkage (%)

Max Working Temp

Min Working Temp

Tear Resistance (N/mm)

Tensile Strength

Thermal Conductivity

Volume Coefficient of Thermal Expansion (ppm/°C)

Youngs Modulus (N/mm²)

Electrical Properties

Dielectric Strength (V/mil)

Dielectric Strength kV/mm

Volume Resistivity (Ohms cm)

Adhesion Testing

Lap Shear Aluminium kg/cm²

Storage

Max Storage Temperature

Min Storage Temperature

Shelf Life

Test Method Value

Thixotropic paste

1 hour at 150°C, 2 hours at 100°C

Addition Heat Cure

440 g/min

Paste

Yes

0.54 MPa / 78 psi

Translucent

BS ISO 2781 1.03 g/cm³

ISO 37 295 %

ASTM D 2240-95 30

291 ppm/°C

2 %

200 °C / 392 °F

-50 °C / -58 °F

BS ISO 34-1 3.1 N/mm / 18 ppi

ISO 37 1.5 N/mm² / 218 psi

0.2 W/mK

874 ppm/°C

0.38 N/mm² / 55 psi

457 V/mil

ASTM D-149 18 kV/mm / 457 V/mil

ASTM D-257 >1E+15 ohms cm

ASTM D1002 8.25 kg/cm²

15 °C / 59 °F

-5 °C / 23 °F

6 mths

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